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Si doping of high-Al-mole fraction Al$_x$Ga$_{1-x}$N alloys with rf plasma-induced molecular-beam-epitaxy

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Successful doping of AlGaN is essential for the realization of many device applications, but it has been known that AlGaN suffers a rapid decrease in the conductivity with increasing Al mole fraction. The unintentional n-type conductivity in AlGaN has been attributed to the incorporation of nitrogen vacancies or oxygen impurities during growth. In the case of n-type doping with oxygen, there were reports that shallow oxygen donor is converted to a deep level by a DX transition when x > 0.4 causing a decrease in the n-type conductivity. For intentional n-type doping of AlGaN, Si is the most widely used dopant. However, the Si donor depth increases with increasing Al mole fraction. There are also reports on the DX state or a localized deep state formation of Si in AlN. It was reported that Si could have a stable deep DX state in AlN and doping efficiency decreases with increasing Al content, while other researchers proposed that Si remains a shallow donor over the whole range of Al$_x$Ga$_{1-x}$N. Experimentally, there have been few reports on high n-type conductivity in high Al mole fraction AlGaN. Si doped Al$_x$Ga$_{1-x}$N grown by molecular-beam epitaxy (MBE) on a Si wafer was reported to have 8 × 10$^{19}$ cm$^{-3}$ electron density when x = 0.4, and Al$_x$Ga$_{1-x}$N:Si grown by metalorganic vapor-phase epitaxy was reported to exhibit 3.1 × 10$^{19}$ cm$^{-3}$ electron concentrations when x = 0.58. In this letter, doping and materials properties of heavily Si-doped, high Al mole fraction AlGaN were investigated.

Si-doped AlGaN was grown in a turbomolecular pumped Varian Gen II MBE system which uses standard effusion cells for the group III elements. An EPI RF plasma source was used for the nitrogen source and 2 in. sapphire wafers with c-plane orientation were used as substrates. After loading into the growth chamber, each wafer was nitried by nitrogen plasma at 200 °C for 30 min and then heated to 830 °C for AlN nucleation layer growth. Si-doped AlGaN wafers with different Al mole fractions and Si fluxes were grown at 800 °C, after the deposition of 200 Å AlN. The growth rate of each sample was almost the same, about 400 Å/h. The Al mole fraction was determined by x-ray diffraction and atomic force microscopy measurements and high optical and morphological qualities were shown. © 2002 American Institute of Physics. [DOI: 10.1063/1.1534395]
tion from $x = 0$ to $x = 0.5$, which is expected if the donor levels are becoming deeper with increasing Al content. Note in Fig. 1 that $n_{c,-V} > n_{\text{Hall}}$ for the higher $x$ values, because deeper donors can contribute to capacitance even though they are not contributing free electrons. Note that all the following electron density and mobility data in this letter were measured by the Hall method and actual Si concentrations of all samples are now under investigation. Figure 2 shows the electron density of different Al mole fraction $\text{Al}_{x}\text{Ga}_{1-x}\text{N}$ samples as a function of reciprocal Si furnace temperature. With increasing Si fluxes, higher electron densities, up to $1.25 \times 10^{20} \text{ cm}^{-3}$, were obtained when $x = 0.5$. $8.5 \times 10^{19} \text{ cm}^{-3}$ electron concentration was also achieved when the Al mole fraction was up to $80\%$. The threshold temperature of the Si furnace for conducting AlGaN increased as the Al mole fraction increased. The minimum electron density that could be measured by the Hall method also increased with increasing Al mole fraction, except one data point in $80\%$ Al mole fraction. Variable temperature Hall measurements were performed in order to find the Si donor ionization energy, but there was no variation at all in the electron density with varying temperature, indicating that the samples were highly degenerate. The results for $65\%$ Al mole fraction AlGaN with $8.8 \times 10^{19} \text{ cm}^{-3}$ electron density and $18 \text{ cm}^2/\text{V s}$ Hall mobility are shown in the inset of Fig. 1.

At very high Si doping density, the Bohr orbital of donor probably overlaps each other. From the Mott-transition condition, $N_D(\text{Mott}) = (0.24 a_B)^3$, $N_D(\text{Mott})$ is estimated to be $8 \times 10^{18} \text{ cm}^{-3}$ for the $65\%$ Al mole fraction AlGaN, where $a_B$ is the Bohr radius of donor electron. Anything above this has metallic, temperature independent conductivity. As the result of the interactions of donors, donor band would start to form near the $N_D(\text{Mott})$ or at a little lower concentration than the $N_D(\text{Mott})$, and at even higher doping density the donor band would widen and finally merge with the conduction band. The increase of the minimum measurable electron density, $n_{\text{min}}$, with increasing Al mole fraction, $x$, suggests that an unknown acceptor is also increasing with $x$ and that this acceptor has a concentration $N_A$ of roughly $n_{\text{min}}$. It is possible that previous attempts to dope AlGaN at high $x$ values failed because the unknown acceptor concentration was too high. In this regard, the very low oxygen contamination of this MBE machine can be another important factor. Secondary ion mass spectroscopy measurements of our MBE grown GaN did not show any oxygen signal within the detection limit ($\text{mid } 10^{16} \text{ cm}^{-3}$) and the GaN was always insulating if there was no intentional doping. This low oxygen contamination can reduce problems associated with Al and enable us to grow higher quality materials.

However, these techniques have not been successful in growing conducting AlGaN when $x > 0.8$. It is interesting that this result coincides well with a theory of dielectric constant change. Figure 3 shows the theoretical Si donor ionization energies in AlGaN with reported experimental data. TO phonon energies of AlGaN are also shown. From a simple hydrogen model, donor ionization energy of $\text{Al}_{x}\text{Ga}_{1-x}\text{N}$ increases from $34 \text{ meV (}x = 0\text{)}$ to $90 \text{ meV (}x = 1\text{)}$ when low-frequency dielectric constants are used. The electron effective mass used here was $0.2m_0(1-x) + 0.48m_0x$ for $\text{Al}_{x}\text{Ga}_{1-x}\text{N}$, applying Vegard’s law. According to the theory, it is necessary to use high-frequency dielectric constant, $\varepsilon(\infty)$, rather than the low-frequency value, $\varepsilon(0)$, when the ionization energy is larger than the transverse optical phonon energy. In AlGaN, this occurs when the Al mole fraction is larger than $\sim 80\%$. Due to the smaller value of $\varepsilon(\infty)$, the donor ionization energy would become much deeper abruptly, when $x > \sim 0.8$. This agrees well with the experimental data. The radius of Si donor electron’s wave function also becomes much smaller in that case and a higher doping density would be needed for degeneracy. This may explain why degenerate doping was difficult to achieve for $x > 0.8$. Recently, there was a report on conducting Si-doped AlN. The ionization energy data in that report also show a sudden increase in the Si donor ionization energy near $80\%$ Al mole fraction, even though the ionization energy is much smaller, $83 \text{ meV in AlN}$, than $320 \text{ meV in the Ref. 12}$. A theoretical AlGaN band gap with experimental data of AlGaN:Si obtained by light absorption, photoluminescence (PL), and cathodoluminescence (CL) is shown in Fig. 4. The bowing parameter used for AlGaN band gap calculation was $1.3 \text{ eV}$. The optical absorption data are in good agreement with the theoretical band gap expectation and the absorption spectra in the inset shows that band edge absorption with heavy Si doping does not have any added significant features. The Burstein–Moss shift observed in a heavily doped semiconductor is not noticeable in the AlGaN:Si and no deep levels or other absorption centers are introduced, which would absorb UV light. These features make the AlGaN:Si very promising materials for UV light emitters or detectors. It seems that band filling effect competes with band tailing and band gap renormalization. PL and CL data show the
The value of FWHM was 

\[
\Delta \omega \approx \frac{1}{\tau}
\]

surface roughness measured by AFM. The inset shows the optical absorption spectra of the AlGaN:Si samples. Samples above 80% Al are insulating.

same trend but have a little lower energy. This may be explained as PL and CL likely come from electrons in the bottom of the band, because they have better k conservation with the holes, which are near k = 0. Also, there could be the band tailing effect, and the localization effect resulting from compositional variation. The PL lifetime was around 180 ps with insignificant dependence on Al mole fraction or doping density.

In contrast to GaN:Si\textsuperscript{18} causing rough surface, the rms surface roughness measured by AFM was significantly smaller for AlGaN:Si layers. The rms value of 80% and 65% Al mole fraction AlGaN samples with \(\sim 1 \times 10^{20} \text{cm}^{-3}\) electron density was 1.2 and 1.3 nm, respectively, and two-dimensional step growth was observed in these samples with concentric and spiral shape steps. There was no disadvantage of high Si doping on the AlGaN surface morphology and the morphology was even improved with Si doping. It was hard to find a general trend of morphology change as a function of electron density. Also, no consistent correlation was observed between the full width at half maximum (FWHM) of x-ray measurements of AlGaN:Si and the electron density. In the 2θ-scans, the smallest value of FWHM was \(\sim 9\) arc min when the Al mole fraction was 0%, or 100% and the FWHMs of other Si-doped AlGaN layers varied within \(\sim 24\) arc min.

In conclusion, very high n-type doping, \(\sim 10^{20} \text{cm}^{-3}\) electron density, of Al\(_{1-x}\)Ga\(_x\)N layers was successfully achieved by MBE in the range of \(0 \leq x \leq 0.8\). Despite the very high Si doping density, there was no significant degradation of materials properties, and, in fact, the layers showed superior optical and structural qualities suitable for device applications.

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\[\text{FIG. 4. Theoretical graph of AlGaN band gap as a function of Al mole fraction, with the experimental data of AlGaN:Si measured by optical absorption, PL, and CL. Each sample has different Al mole fraction and electron density, } n. \text{ The inset shows the optical absorption spectra of the AlGaN:Si samples. Samples above 80% Al are insulating.}\]


\[\text{18} \] http://www.iiv.cornell.edu/www/schaff/muri/reports/fy97q2/2nd.html

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